

US00D934874S

(12) **United States Design Patent** (10) **Patent No.:** **US D934,874 S**
Siminoff et al. (45) **Date of Patent:** **** Nov. 2, 2021**

(54) **DEVICE MOUNT**

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(**) Term: **15 Years**

(21) Appl. No.: **29/723,148**

(22) Filed: **Feb. 4, 2020**

Related U.S. Application Data

(62) Division of application No. 29/648,051, filed on May
17, 2018, now Pat. No. Des. 878,380.

(51) **LOC (13) Cl.** **08-07**

(52) **U.S. Cl.**
USPC **D14/447**

(58) **Field of Classification Search**
USPC D14/447, 432, 434, 439, 440, 451, 452,
D14/457, 239, 253; D8/363, 373, 380;
D6/406.3, 406.4, 406.5, 406.6; D19/78,
D19/86, 87, 91

CPC A47B 21/04; A47B 2097/006; A47B
2097/005; A47B 2023/049; A45C
2011/002; A45C 2011/003; F16M
2200/00; F16M 13/00

See application file for complete search history.

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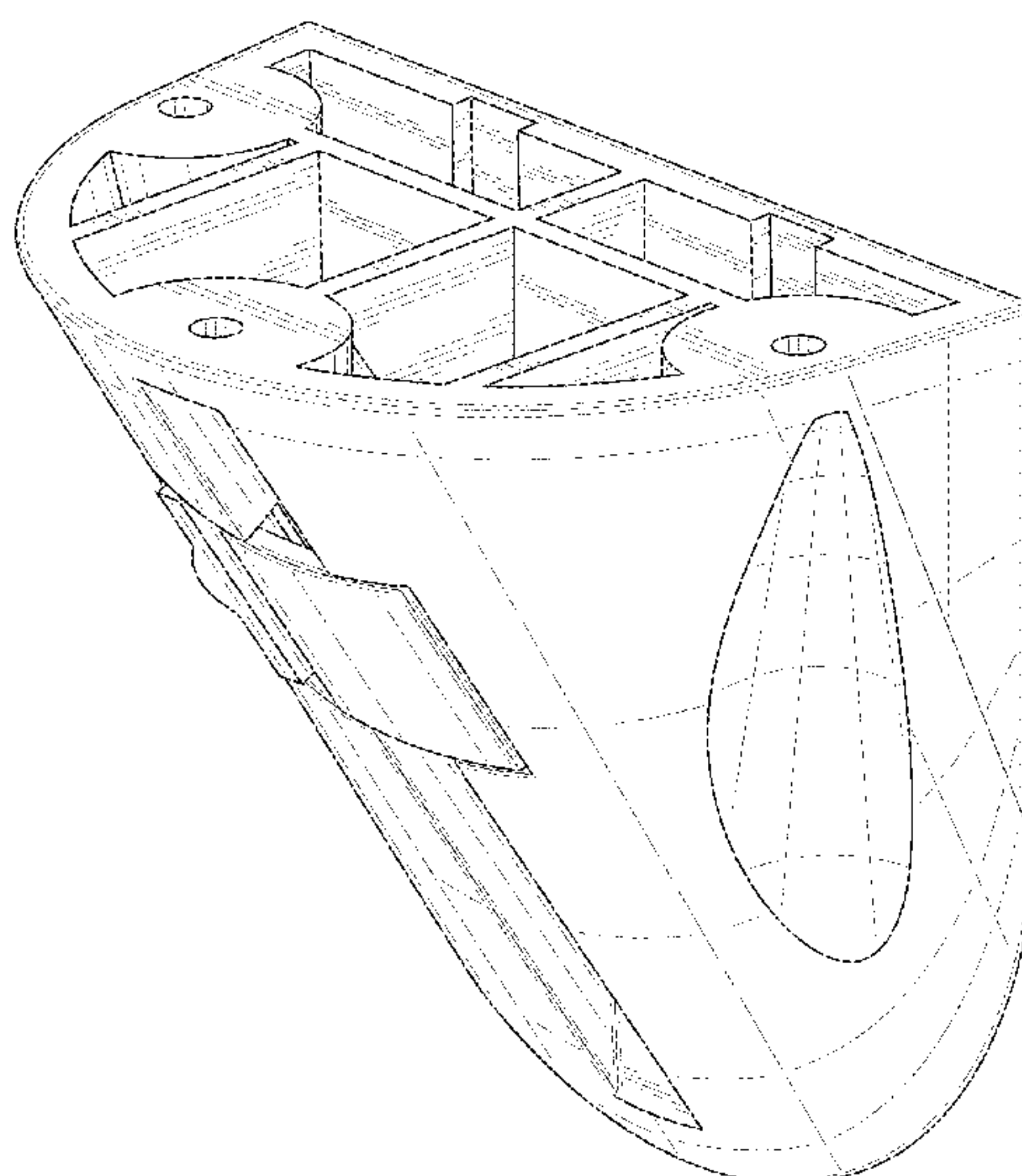
(57) **CLAIM**

The ornamental design for a device mount, as shown and
described.

DESCRIPTION

FIG. 1 is a front perspective view of a device mount;
FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a left-side elevational view thereof;
FIG. 5 is a right-side elevational view thereof;
FIG. 6 is a top plan view thereof; and,
FIG. 7 is a bottom plan view thereof.
The shade lines in the figures show contour and not surface
ornamentation.

1 Claim, 7 Drawing Sheets



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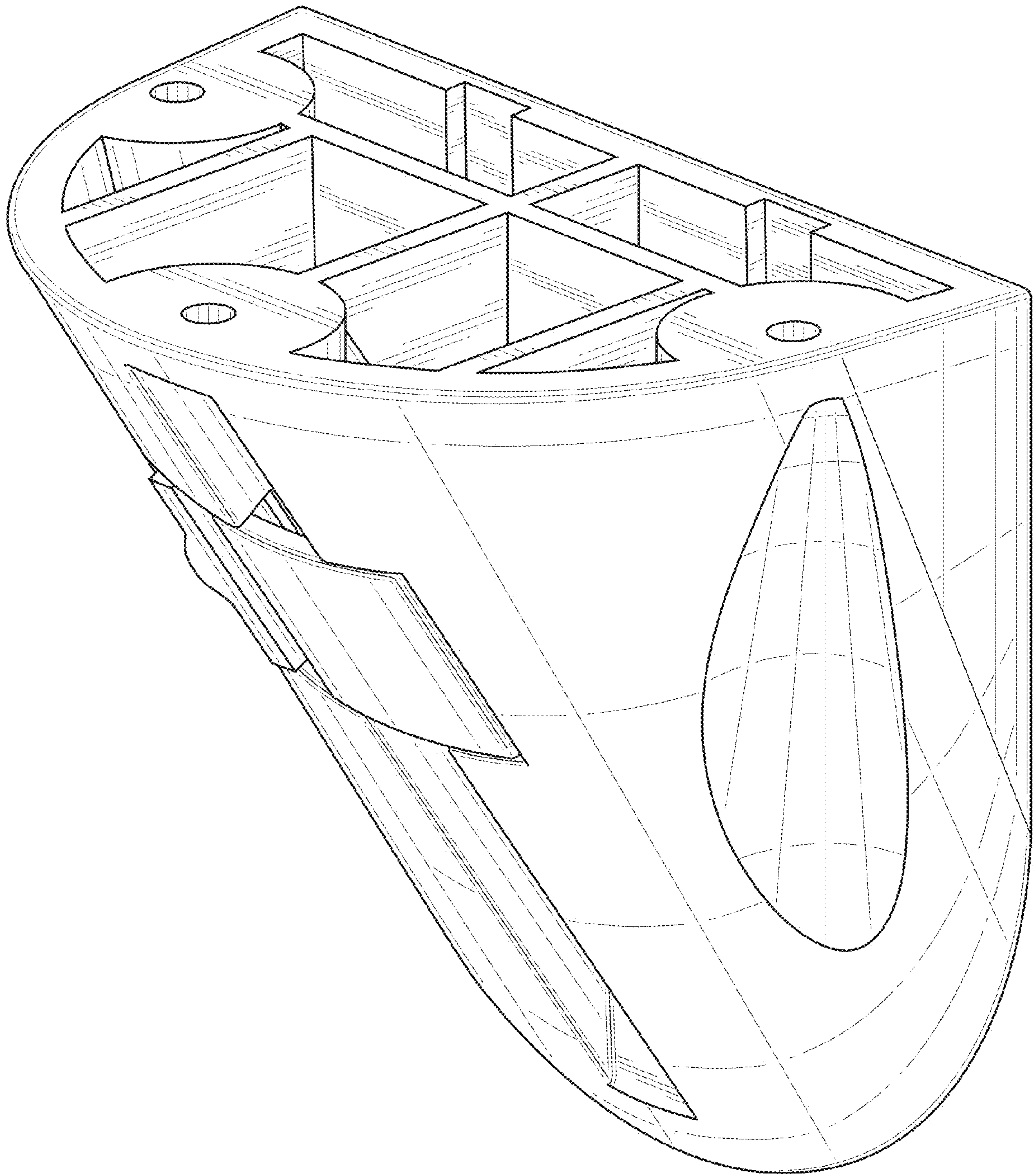


FIG. 1

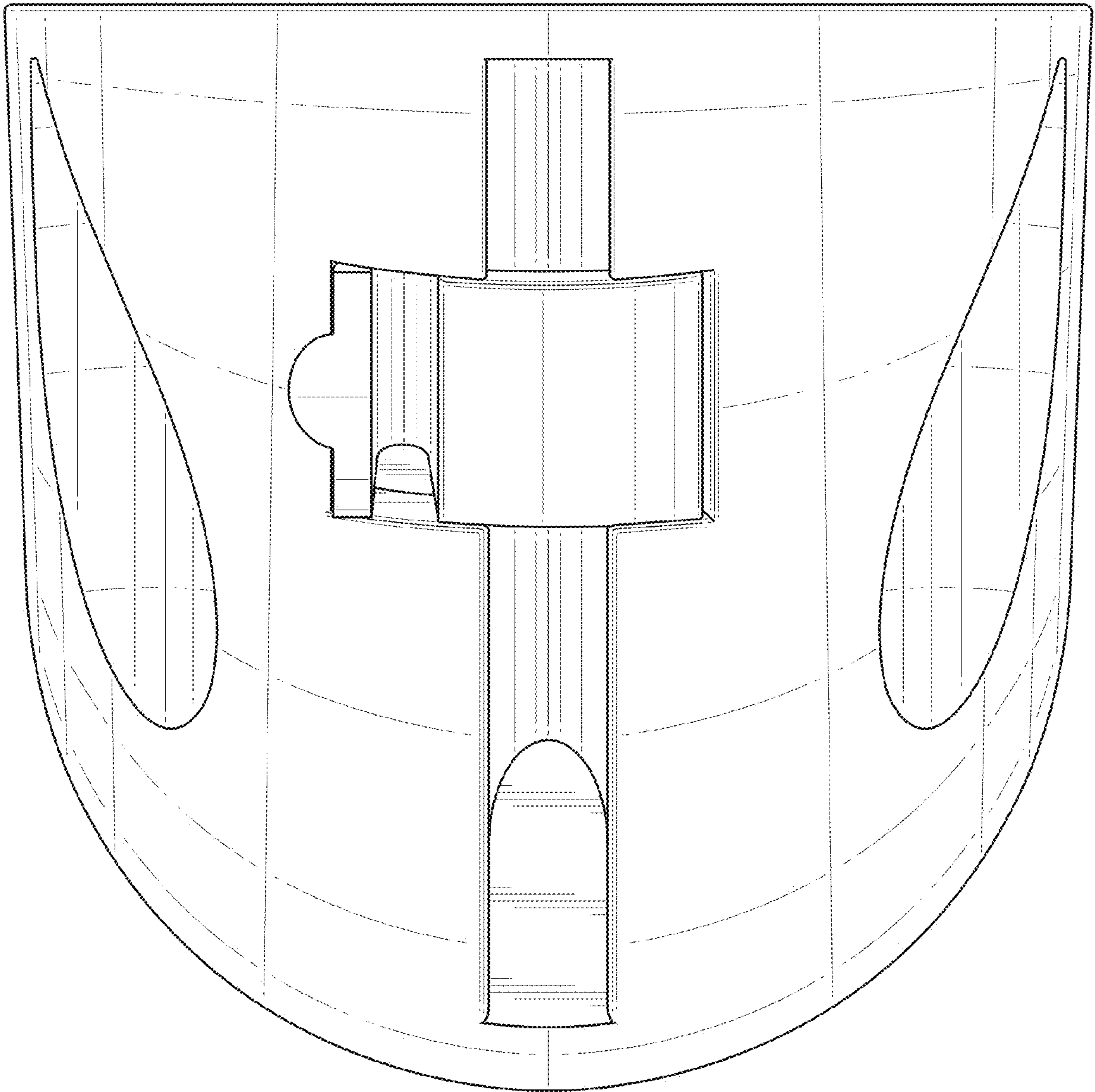


FIG. 2

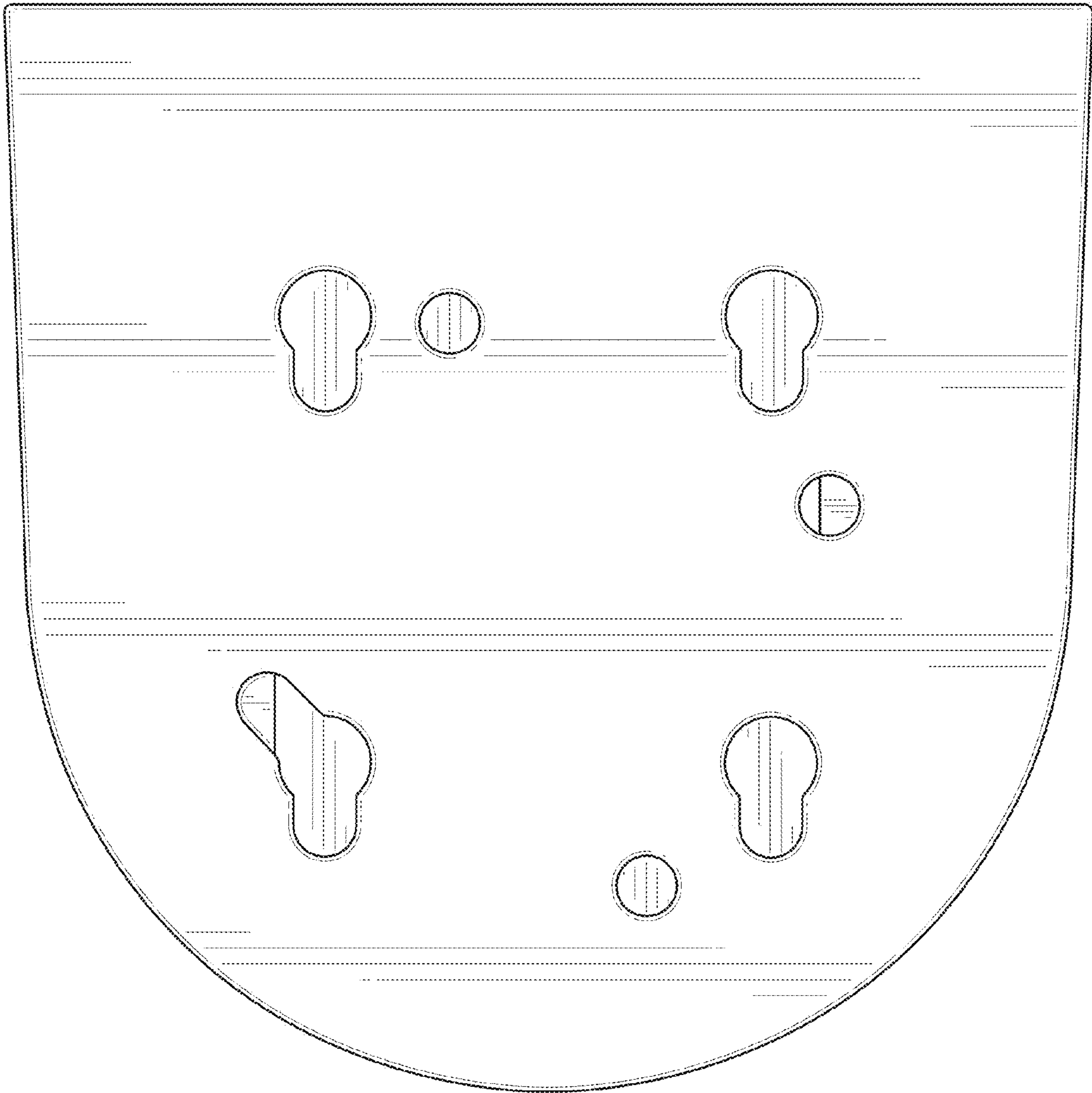


FIG. 3

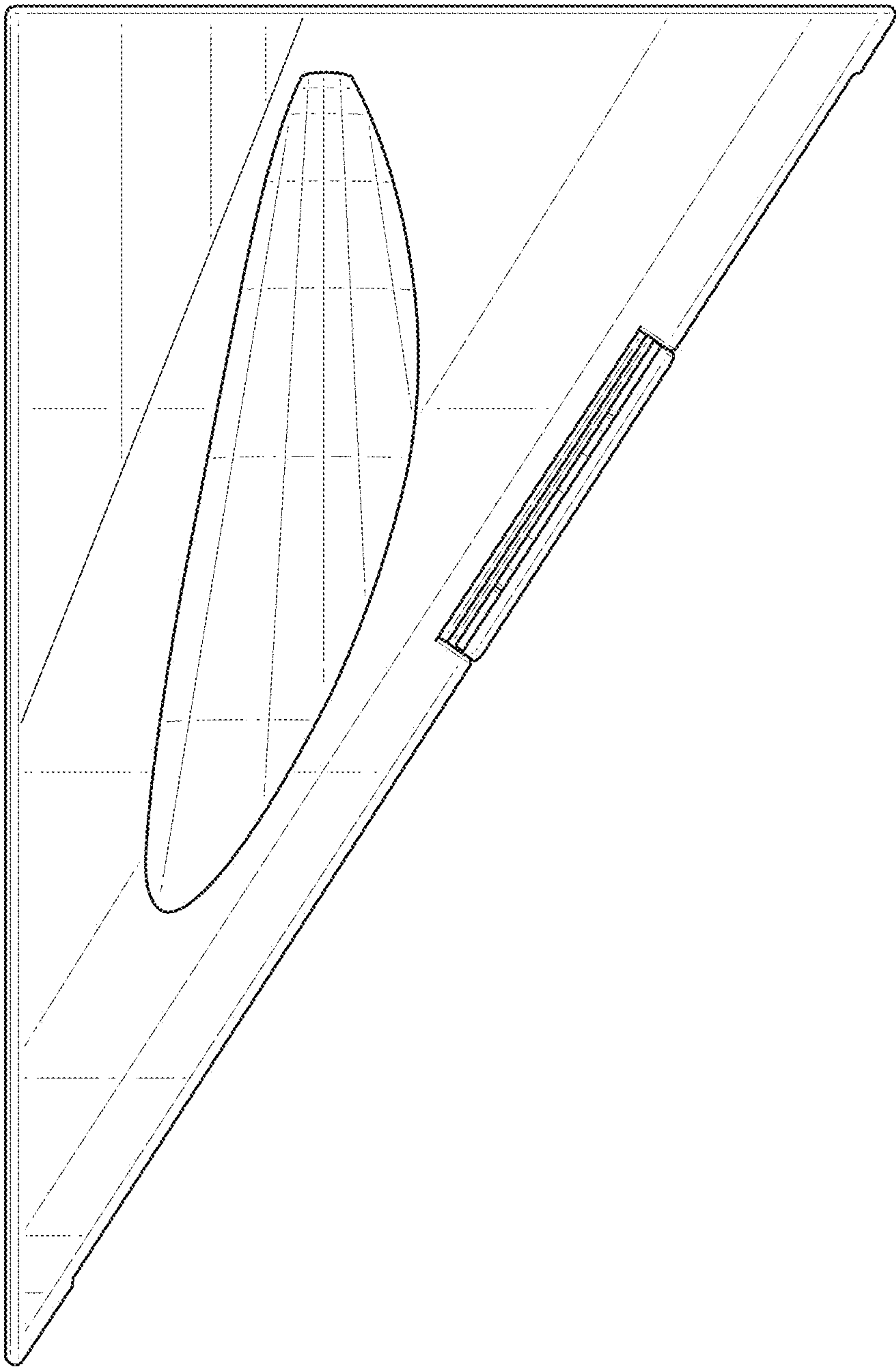


FIG. 4

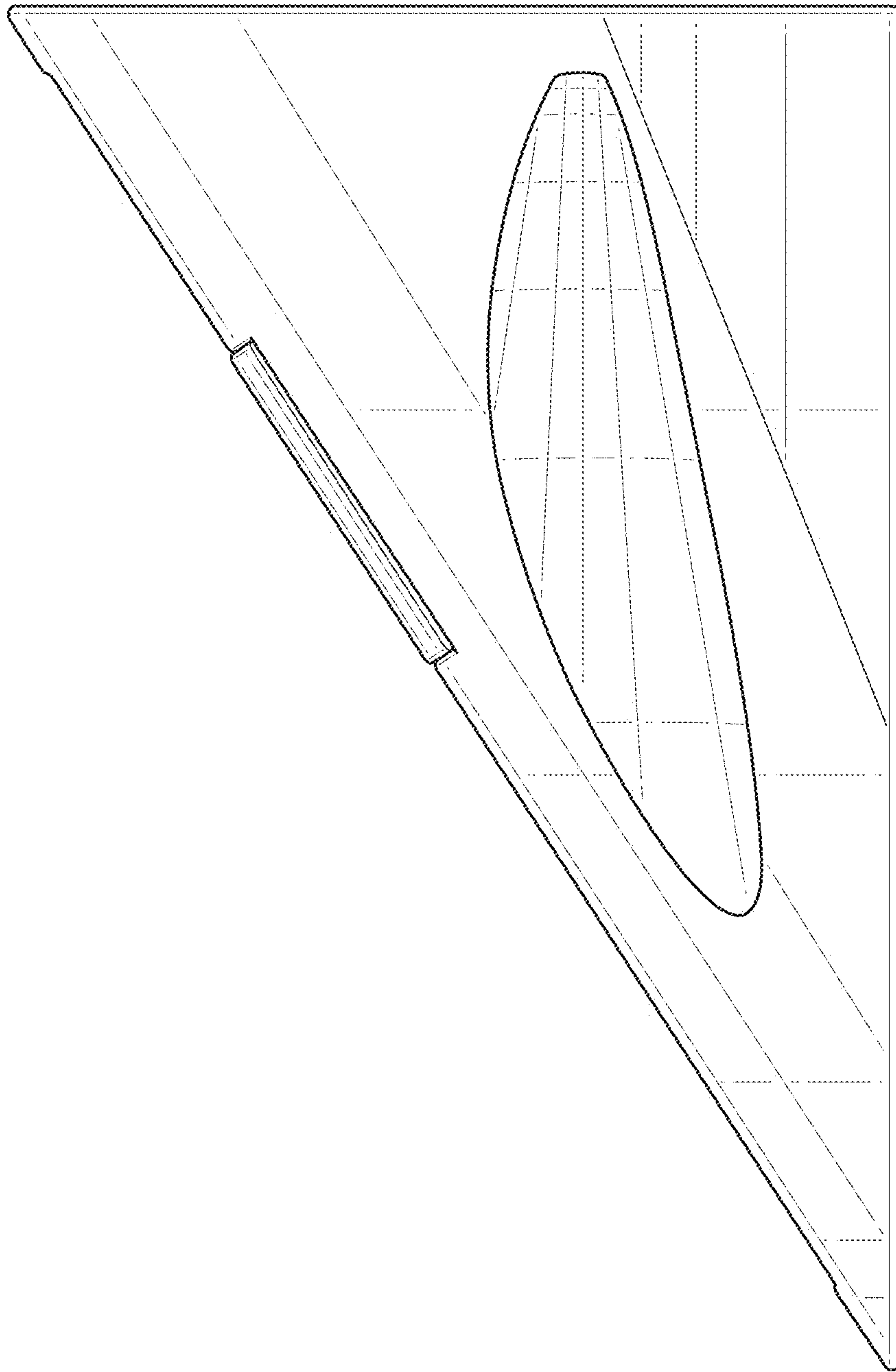


FIG. 5

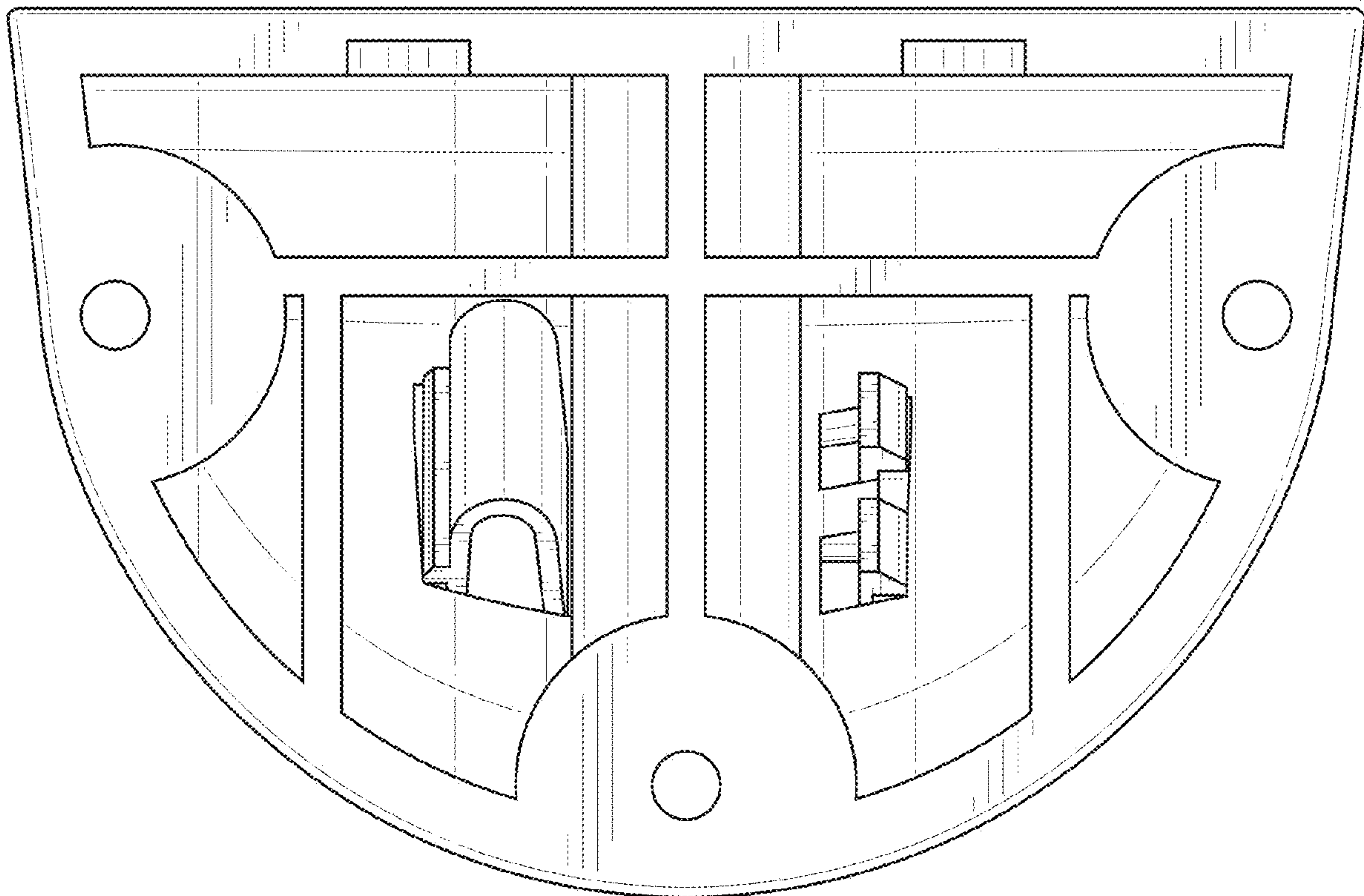


FIG. 6

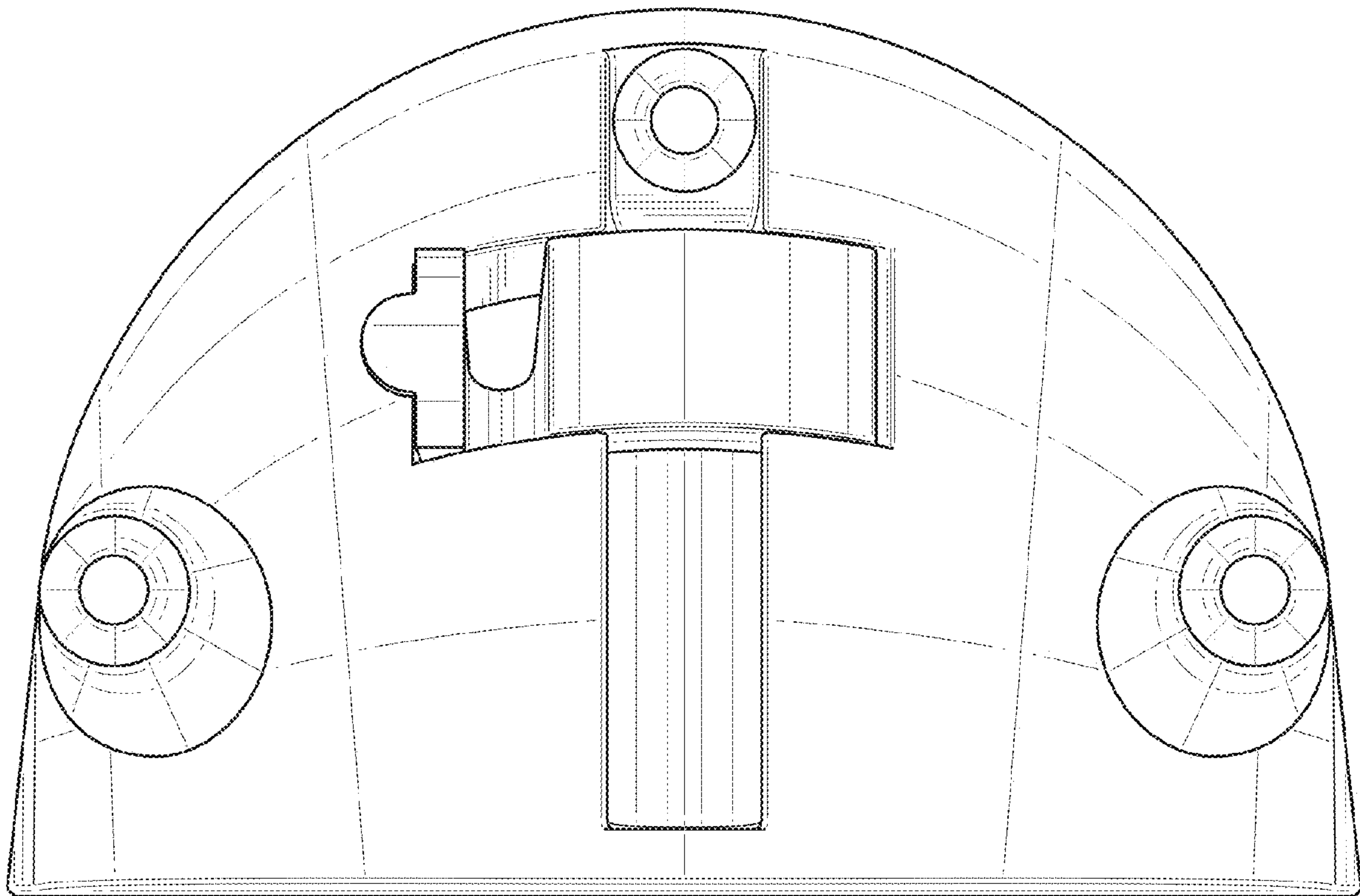


FIG. 7